CLIPPEDIMAGE= JP404239168A

PAT-NO: JP404239168A

DOCUMENT-IDENTIFIER: JP 04239168 A

TITLE: SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE

PUBN-DATE: August 27, 1992

INVENTOR-INFORMATION:

NAME

USAMI, MITSUO

ASSIGNEE-INFORMATION:

NAME COUNTRY HITACHI LTD N/A

APPL-NO: JP03002395

APPL-DATE: January 14, 1991

INT-CL (IPC): H01L025/00; H01L021/60; H01L023/12; H01L027/00

;H01L027/04

US-CL-CURRENT: 257/737,257/777

ABSTRACT:

PURPOSE: To reduce noise generated in a common wiring for a power supply system of a large scale integrated circuit device which carries out very fast , operation.

CONSTITUTION: Take-out electrodes 8a and 8b from power supply wirings VCC<SB>1</SB> and VEE<SB>1</SB> which supplies power supply voltage to an SPL circuit which constitutes a semiconductor circuit formed on a semiconductor chip 4 are formed on the upper most layer on a main side of the aforesaid

semiconductor chip 4 and the aforesaid take out electrodes 8a and 8b are

## **BEST AVAILABLE COPY**

02/22/2003, EAST Version: 1.03.0002

connected with take-out electrodes from a plate capacitor CX by way of a bump 5 so that the plate capacitor CX may be electrically connected between the aforesaid power supply wirings VCC<SB>1</SB> and VEE<SB>1</SB>.

COPYRIGHT: (C)1992, JPO&Japio

